





(0.635 mm) .025" PITCH • QMS/QFS SERIES

QMS **Board Mates: OFS**

QFS Board Mates: OMS

QMS/QFS

Cable Mates: 6QCD

Standoffs: SO, JSOM

SPECIFICATIONS

Insulator Material: Liquid Crystal Polymer Contact & Ground Plane Material: Phosphor Bronze Plating: Au over 50 μ" (1.27 μm) Ni (Tin on Ground Plane Tail) Current Rating: Contact:

2.6 A per pin (2 pins powered) **Ground Plane:** 15.7 A per ground plane (1 ground plane powered)

Operating Temp Range: -55 °C to +125 °C **Voltage Rating:** 300 VAC when mated

PROCESSING

Lead-Free Solderable: QMS SMT Lead Coplanarity:

(0.10 mm) .004" max (026-052)(0.15 mm) .006" max (078)* *(.004" stencil solution may be available; contact

IPG@samtec.com)

QFS SMT Lead Coplanarity: (0.10 mm) .004" max (026-078)

Board Stacking:

For applications requiring more than two connectors contact ipg@samtec.com

STANDARDS

SUMIT™ PCI/104-Express™ OneBank

for more information, including mated heights and complete part numbers.

PINS PER ROW QMS NO. OF PAIRS

-026, -052, -078

LEAD

STYLE

Specify

LEAD

STYLE

from

Chart

(52 total pins per bank = -D)

-016, -032, -048

(16 pairs per bank = -D-DP)

(–078 & –048 N/A with –09.75 Lead Style)

MATED HEIGHT* QFS LEAD STYLE QMS LEAD Α -4.25 -6.25 -05.75 (5.38) .212 10 mm 12 mm -06.75 (6.35) .250 11 mm 13 mm -09.75 (9.35) .368 14 mm 16 mm

*Processing conditions will affect mated height. See SO Series for board space tolerances.

PLATING OPTION

= 10 µ" (0.25 µm) gold on contact, Matte Tin on tail (-05.75 & -06.75 Lead Style Only)

-SL = 10 μ" (0.25 μm) gold on contact, Matte Tin on tail (-09.75 Lead Style Only)

-D = Single-Ended

TYPE

-D-DP = Differential Pair

1.60 mm

Nominal

Wipe

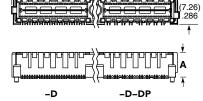
-K = (5.50 mm) .217" DIA Polyimide film Pick & Place Pad

OTHER

OPTION

PACKAGING OPTION

Tape & Reel Options (-TR & -FR) available. Visit series web page and view engineering prints for complete specifications.



(No. of Banks) x (21.34) .840 - (0.51) .020



View complete specifications at: samtec.com?QMS

PINS PER ROW NO. OF PAIRS LEAD STYLE OTHER OPTION **QFS PLATING OPTION**

-026, -052, -078 (52 total pins per

-016, -032,

-048

(16 pairs per bank = -D-DP)

bank = -D

Specify LEAD **STYLE** from Chart

= 10 μ" (0.25 μm) gold on contact, Matte Tin on tail (-04.25 Lead Style only)

-SL = 10 μ" (0.25 μm) gold on contact, Matte Tin on tail (-06.25 Lead Style only)

-D = Single-Ended

-D-DP = Differential Pair (-04.25 Lead Style only)

-GP = Guide Holes (-04.25 Lead Style only)

PACKAGING OPTION

Tape & Reel Options (-TR & -FR) available. Visit series web page and view engineering prints for complete specifications.

Visit samtec.com/standards

→ GP = No. of Banks x (21.34) .840 + (12.45) .490 ← No. of Banks x (21.34) .840 + (1.02) .040 = (8.13).320 (0.89) .035

_	
<u> </u>	
→ (8.13) ← .320	

LEAD STYLE	A
-04.25	(7.44) .299
-06.25	(9.42) .371

Note:

Some lengths, styles and options are non-standard, non-returnable.

View complete specifications at: samtec.com?QFS

See pg 46-47 for Right-Angle & Edge Mount options.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Board to Board & Mezzanine Connectors category:

Click to view products by Samtec manufacturer:

Other Similar products are found below:

589158040000018 MDF7C-18P-2.54DSA(55) FCN-230C068-11 FCN-268F012-G/BD FCN-268F036-G/BD FCN-268M012-G/0D FCN-268M024-G/1D FCN-723J004/1 MIS-048-01-F-D-DP-K 832-10-034-10-001000 FX4C-80S-1.27DSA FCN-214Q030-G/0 FCN-234P048-G/0 FCN-235D050-G/C 210-93-314-41-105000 2-22603-0 MDF7-40DP-2.54DSA(55) AXG720047 5031084030 MIT-114-03-F-D-K 55323-1519 DF33-2P-3.3DSA(24) YFT-20-05-H-03-SB-K 503308-3040 026-6203-PDB 027-6203-PDB 069159702701000 10123981-102LF 101A10019X 55650-0588-C 68684-306 75140-7012 589159005003045 194261-1 FCN-268F024-G0D 10124054-515LF 68685-603 8-1616154-3 MIS-019-01-F-D 589159005002045 541371078 IL-WX-10PB-HF-B-E1000E FCN-268M024-G/3D 20021832-06016C1LF KX15-20KLDL-E1000E MDF7-16DP-2.54DSA(55) AXE810124 FCN-214J100-G/0 FCN-230C068-E/S AXE812124